Overview

HP ZBook Power G10 A Mobile Workstation PC



- 1. Webcam LED (Optional)
- 2. Internal Microphones (2)
- 3. Webcam
- 4. IR Camera (Optional)
- 5. Camera Shutter
- 6. IR Camera LEDs (Optional)
- 7. Glass Clickpad
- 8. Power Button Key
- 9. LED Indicator

Right

- 10. Power connector
- 11. USB Type-C[®] with Thunderbolt[™] 4
- 12. USB 3.2 Gen 1
- 13. USB 3.2 Gen 1
- 14. Audio Combo Jack
- 15. Touch Fingerprint Sensor (Select models)
- 16. Speakers



Overview

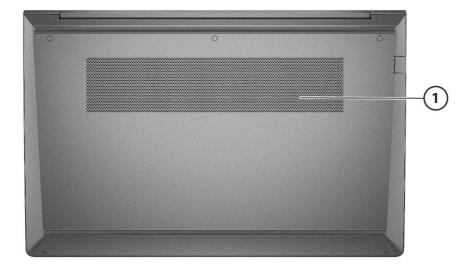


Left

- 1. Nano Security Lock Slot (Lock sold separately)
- 2. RJ-45
- 3. SuperSpeed USB Type-A 5Gbps signaling rate (Charging)
- 4. HDMI 2.1 Port (Cable not included)
- 5. Smart Card Reader (optional)



Overview



Bottom

1. Fan Venting



Overview

At A Glance

- Premium ultraslim design with precision-crafted all-metal chassis for a premium look and feel
- Latest AMD[®] Ryzen PRO 7000 HS series processors and AMD[®] Ryzen 7000 HS series processors
- Preinstalled with Windows 11 versions or FreeDOS
- 5MP camera (with 88 degree Field of View) with HP Auto Frame allows you to move around without losing viewers' attention during video calls
- New DDR5 5600 memory and PCI Gen4 SSDs provide fast access to your work
- Choice of displays:
 - o 39.6 cm (15.6") diagonal, FHD (1920 x 1080), narrow bezel, anti-glare, Touch on Panel (TOP), 250nits, 45% NTSC
 - o 39.6 cm (15.6") diagonal, FHD (1920 x 1080), narrow bezel, anti-glare, 250 nits, 45% NTSC
 - 39.6 cm (15.6") diagonal, FHD (1920 x 1080), narrow bezel, anti-glare, Low Blue Light, 400nits, Low-Power, 100% sRGB
 - o 39.6 cm (15.6") diagonal, QHD (2560 x 1440), narrow bezel, anti-glare, Low Blue Light, 300 nits, 100% sRGB
- Premium keyboard layout to include easy use of discrete PgUp/Dn, End, and Home keys
- Integrated AMD Radeon Graphics w/ Pro Graphics driver or Optional NVIDIA RTX A1000/2000/4050 ada pro graphics for improved performance for heavier graphics workloads.
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.9
- Larger Clickpad surface for easier, more intuitive input
- Undergoes MIL-STD 810H 19 tests
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled OS

Windows 11 Pro² Windows 11 Pro Education² Windows 11 Home - HP recommends Windows 11 Pro for business² Windows 11 Home Single Language - HP recommends Windows 11 Pro for business² Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing Agreement)² Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade)^{2,3} FreeDOS

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

PROCESSOR

AMD Ryzen[™] 5 7640HS (with Radeon NAVI 3 Graphics 4.3 GHz base clock, up to 5.0 GHz max boost clock, 16 MB L3 cache, 6 cores, 12 threads)^{1,2,4}

AMD Ryzen[™] 5 PRO 7640HS (4.3 GHz base clock, up to 5.0 GHz max boost clock, 16 MB L3 cache, 6 cores, 12 threads)^{1,2,4}

AMD Ryzen[™] 7 7840HS (with Radeon NAVI 3 Graphics 3.8 GHz base clock, up to 5.1 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads)^{1,2,4}

AMD Ryzen[™] 7 PRO 7840HS (3.8 GHz base clock, up to 5.1 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads) ^{1,2,4}

AMD Ryzen[™] 9 7940HS (with Radeon NAVI 3 Graphics 4.0 GHz base clock, up to 5.2 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads)^{1,2,4}

AMD Ryzen™ 9 PRO 7940HS (with Radeon NAVI 3 Graphics 4.0 GHz base clock, up to 5.2 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads)^{1,2,4}

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering, branding and/or naming is not a measurement of higher performance.

² Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
 ⁴ In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



Features

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon[™] Graphics^{3, 4, 5,}

Discrete

NVIDIA RTX A1000 (6 GB) ^{2,3,4,5} NVIDIA RTX 2000 Ada (8GB) ^{2,3,4,5} NVIDIA GeForce RTX 4050 ^{1,2,3,4,5}

Supports

Support HD decode, DX12, HDMI 2.1, HDCP 2.3

¹ Only available for China.

² Both UMA & Discrete configurations support 4 independent displays when on the HP Thunderbolt Dock G2 (120W) (sold separately) - Max. resolution = 2.5K @60Hz (DP1) & 2.5K @60Hz (DP2) & FHD (VGA) OR 4K @60Hz (one DP Port) & 4K @60Hz (Type-C output port using a Type C-to-DP adapter).

³ Support HD decode, DX12, HDMI 2.0b, HDCP 2.3 via DP up to 4K @ 60Hz and via HDMI up to 4096x2304 @ 60Hz ⁴ HDMI cable Sold Separately

⁵ Shared video memory (UMA) uses part of the total system memory for video performance. System memory dedicated to video performance is not available for other use by other programs.

DISPLAY

Non-touch

- 39.6 cm (15.6") diagonal, FHD (1920 x 1080), narrow bezel, anti-glare, 250 nits, 45% NTSC
- 39.6 cm (15.6") diagonal, FHD (1920 x 1080), narrow bezel, anti-glare, Low Blue Light, 400nits, Low-Power, 100% sRGB
- 39.6 cm (15.6") diagonal, QHD (2560 x 1440), narrow bezel, anti-glare, Low Blue Light, 300 nits, 100% sRGB

Touch

• 39.6 cm (15.6") diagonal, FHD (1920 x 1080), narrow bezel, anti-glare, Touch on Panel (TOP), 250nits, 45% NTSC

Displays support

Supports up to 4 displays through the HP Thunderbolt 280W G4 Dock

¹HD content required to view HD images.
²Sold separately or as an optional feature.
³Resolutions are dependent upon monitor capability, and resolution and color depth settings.
⁴Actual brightness will be lower with touchscreen.



Features

DOCKING

Docking station model #1	HP Thunderbolt™ 280W G4 Dock
Total number of supported displays (incl.the notebook) display)	4
Max.resolutions supported	Quad 4K @60Hz Dual 8K single cable@30 for Thunderbolt™ hosts or USB-C® hosts DisplayPort™ 1.4 with DSC in high res mode
Dock Connectors	2xDisplayPort™, 1xVGA, 1xThunderbolt™, 1xUSB-C® alt-mode
Technical limitations	Thunderbolt [™] Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt [™] host. Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt [™] host or running a non-Thunderbolt [™] host in High Resolution mode @30Hz Non-Thunderbolt [™] hosts: The highest resolution for dual displays running a non-Thunderbolt [™] host in multi-function mode is (1) 5K dual cable (using both DisplayPort [™] ports) +(1) 4K on USB-C [®] DisplayPort [™] port Non-Thunderbolt [™] hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.

Features

STORAGE AND DRIVES*

Max Storage

8TB through two m.2 NVMe drivers

(Up to 2) m.2 storage (NVMe PCIe Gen4 SSDs)

Primary M.2 Storage

2 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 1 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 4 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 512 GB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 512 GB PCIe[®] Gen4x4 NVMe[™] SED TLC OPAL2 512 GB PCIe[®] NVMe[™] Value M.2 SSD

Secondary M.2 Storage

2 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 1 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 4 TB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 512 GB PCIe[®] Gen4x4 NVMe[™] M.2 SSD TLC 512 GB PCIe[®] Gen4x4 NVMe[™] SED TLC OPAL2

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of disk is reserved for system recovery software.

DRIVE CONTROLLERS

M.2 Storage Bay (PCIe NVMe) RAID: PCIe[®] Gen4 x4 lanes NVMe[™] Solid State Drive RAID 0/1 is supported (and available from factory)

MEMORY

Maximum Memory 64GB DDR5-4800 Memory 64GB DDR5-5600 (2x32GB) 32GB DDR5-5600 (2x16GB) 32GB DDR5-5600 (1x32GB) 16GB DDR5-5600 (1x8GB) 16GB DDR5-5600 (1x8GB)

Memory Slots 2 SODIMM DDR5 SODIMMS, system runs at 5600 Supports Dual Channel Memory

¹ Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



Features

NETWORKING/COMMUNICATIONS

Ethernet

RTK GBE Ethernet Controller (Non-DASH QFN32) RTL8111HSH-CG RTK GBE Ethernet Controller RTL8111FPH-CG LAN CHIP

WLAN¹

Mediatek RZ616 Wi-Fi 6E Bluetooth[®] 5.3 AIM-T WLAN wireless card Realtek 8852CE Wi-Fi 6E Bluetooth[®] 5.3 WLAN wireless card

¹ Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Near Field Communication (NFC) module

No Near Field Communication (NFC) module NFC Mirage WNC XRAV-1

Miracast

Native Miracast Support

NOTE: Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Discrete Amplifiers Integrated dual array microphone

Speaker Power 2W/40hm Per speaker

Camera^{1, 2}

HD camera 5 MP+IR camera

Sensors

Hall effect Sensor HP Sure Platform Motion AI LSM6DSL Thermal Sensor HP Tamper Lock³

¹ HD content required to view HD images.

² Windows Hello face authentication utilizes a camera specially configured for near infrared (IR) imaging to authenticate and unlock Windows devices as well as unlock your Microsoft Passport.
 ³ HP Tamper Lock must be enabled by the customer or your administrator.



Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard*

HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys HP Premium Keyboard, spill resistant, Non-Backlit keyboard and DuraKeys

Pointing Devices

Clickpad with multi-touch gesture support, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

Function Keys

ESC: system information F1 - Display Switching F2 - Blank F3 - Brightness Down F4 - Brightness Up F5 - Audio Mute F6 - Volume Down F7 - Volume Up F8 - Mic Mute F9 - Blank or Backlit Toggle F10 - Insert F11 - Airplane Mode F12 - HP Command Center home end Power Button (with LED) delete **Hidden Keys** Fn+R - Break Fn+S - Sys Rg Fn+C - Scroll Lock

*Backlit keyboard is an optional feature.

SOFTWARE AND SECURITY

Software

HP PC Hardware Diagnostics Windows Touchpoint Customizer for Commercial myHP HP Smart Support²⁴ HP Connection Optimizer¹⁰ HP Mac Address Manager HP Hotkey Support HP Support Assistant¹ HP Notifications HP Privacy Settings HP Power Manager³ Buy Microsoft Office (Microsoft Office sold separately and requires Internet access for activation.) HP Performance Advisor⁵

Manageability Features

HP Connect for Microsoft Endpoint Manager²⁶ HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)¹²



Features

HP Client Management Script Library (download) HP Patch Assistant (download)²⁷ HP Driver Packs (download) HP Cloud Recovery ²⁸ HP Client Catalog (download)

Security Management

HP Wolf Security of Business ²⁹ includes: HP Sure Click ³⁰ HP Sure Sense¹⁹ HP Sure Run Gen5³¹ HP Sure Recover Gen5¹⁴ HP Sure Start Gen7¹⁶ HP Tamper Lock⁴ HP Sure Admin²³ HP Client Security Manager Gen7¹⁸

BIOS

HP BIOSphere Gen6⁶ HP Secure Erase¹⁷ Absolute Persistence Module⁷ HP DriveLock & Automatic DriveLock BIOS Update via Network HP Wake on WLAN HP Fingerprint Sensor³² Secured-Core PC Enable²⁰ TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

¹ HP Support Assistant - Requires Windows and Internet Access.

³HP Power Manager requires Windows 10 and higher and can be downloaded from the Microsoft Store.

⁴HP Tamper Lock must be enabled by the customer or your administrator.

⁵ HP Performance Advisor is ready and waiting to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: https://www.hp.com/us-en/workstations/performanceadvisor.html

⁶ HP BIOSphere Gen6 is available on select HP Pro, Elite and ZBook PCs. See product specifications for details. Features may vary depending on the platform and configurations.

⁷ Absolute Persistence Module: Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software. ¹⁰ HP Connection Optimizer requires Windows 10 and beyond version.

¹² HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

¹⁴ HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

¹⁵ HP Sure Recover with Embedded Reimaging Gen3 is an optional feature which must be configured at purchase with a base unit that has the On System Recovery (OSR) module. See product specifications for availability You must back up important files, data, photos, videos, etc. before use to avoid loss of data. HP Sure Recover with Embedded Reimaging (Gen1) does not support platforms with Intel[®] Optane[™].

¹⁷ HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane[™].

¹⁸ HP Client Security Manager Gen7 requires Windows and is available on select HP Pro, Elite and ZBook PCs. See product specifications for details.

¹⁹ HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.



Features

²⁰ Secured-core PC requires an Intel[®] vPro[®] or AMD Ryzen[™] Pro processor. Requires 8 GB or more system memory. Secured-core PC functionality can be enabled from the factory.

²³ HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

²⁴ HP Smart Support requires HP TechPulse to be installed. For more information about how to enable or to download HP Smart Support, please visit http://www.hp.com/smart-support.

²⁶ HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.
²⁷ HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center

Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

²⁸ HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

²⁹ HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

³⁰ HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

³¹ HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

³² HP Fingerprint Reader is an optional feature that requires Windows 10 IoT and must be configured at purchase.



Features

POWER

Power Supply

HP Smart 120 W External AC power adapter³ HP Smart 150 W External AC power adapter⁴

Battery

HP Long Life 6-cell, 83 Wh Li-ion Polymer

Power Cord 3-wire plug - 1m

Battery life

Up to 19 hours 30 minutes (UMA SKU) 14 hours 30min (discrete GFX SKU)

¹ MobileMark18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

² Battery is internal and not replaceable by customer. Serviceable by warranty.

³Only available with UMA graphics

⁴ Only available with discrete graphic options

⁵Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

ENVIRONMENTAL

ENERGY STAR® certified EPEAT® registered where applicable. EPEAT® registration varies by country. See www.epeat.net for registration status by country. EPEAT® Gold¹ TCO 8.0 Certified RCTA DO-160G Medical EMC: IEC 60601-1-2:2014 EN60601-1-2: 2015 SEPA GS Mark Evesafe Certification - Worldwide

Sustainable Impact Specifications

Recycled Aluminum and Magnesium, 75% PCR w/30% ITE plastics

¹ Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. Status varies by country. Visit www.epeat.net for more information.



Features

WEIGHTS & DIMENSIONS

Dimensions (w x d x h) 35.94 x 23.39 x 2.29 cm 14.15 x 9.21 x 0.9 in

Weights*

Starting at 1.96 kg (4.32 lb)

*Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

- 1 Thunderbolt[™] 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
- 3 Super Speed USB Type-A 5Gbps signaling rate (1 charging)

1 HDMI 2.1

1 Headphone/microphone combo jack

- 1 Nano Security Lock Slot (Lock sold separately)
- 1 Smartcard reader (Optional)

*SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4. *HDMI cable sold separately.

COMPATIBILITY

HP Wired USB-A Stereo Headset	428K6AA
HP Renew Business 17.3 Laptop Backpack	3E2U5AA
HP Universal USB-C Multiport Hub	50H55AA
HP Multi-Device 635 Black Wireless Mouse	1D0K2AA
HP 975 USB+Bluetooth [®] Dual-Mode Wireless Keyboard	3Z726AA

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

¹HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

SYSTEM UNIT

Stand-Alone Power Nominal Operating Requirements (AC Power) Voltage

(III)

19.5V

Features

	System in idle mode + max panel brightness	8.09W
	Integrated graphics	Yes
	Discrete Graphics	Yes
	Max Operating Power	<150W
Temperature	Operating	32° to 95° F (0° to 35° C)
	Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	Operating	10% to 90%, non-condensing
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	Operating	40G, 2ms
	Non-operating	240G, 2ms
Random Vibration	Operating	1.043 grms
	Non-operating	3.5 grms
Maximum Altitude	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
(unpressurized)	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Temperature Derating with Altitude	Operating	1.8°F / 1000 ft (1°C / 304.8 m)
Planned Industry Standard Certifications	Regulatory Model Number	HSN-Q37C
	CSA/UL 62368-1	Yes
	CSA	Yes
	FCC/ICES/CISPR/VCCI	Yes
	ENERGY STAR®	Select models ¹
	EPEAT Gold	EPEAT Gold in United States ²
	TCO	Yes
	China CCC/SRRC	Yes
	Korea KCC/KC/KES	Yes
	Taiwan BSMI/NCC	Yes
	CE MARKING	Yes
	EAEU compliance	Yes
	CITC	Yes
	WW RoHS	Yes
	EAEU compliance	Yes
	Saudi Arabian Compliance	Yes
	Ukraine NSoC/TEC	Yes
	Low Bluw Light	Yes

¹Configurations of the HP ZBook Power G10 A Mobile Workstation PC that are ENERGY STAR® qualified are identified as HP ZBook Power G10 A Mobile Workstation PC ENERGY STAR on HP websites and on http://www.energystar.gov. ²Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit www.epeat.net for more information.



Technical Specifications – Displays

DISPLAYS

Panel LCD 15.6 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent Touch on Panel NWBZ

Outline Dimensions (W × H)	350.96 x 205.74 mm (n	nax)	
Active Area	344.16 x 193.59 mm (typ.)		
Weight	380 g (max)		
Diagonal Size	15.6 inch		
Thickness	3.2 mm / 5.2 mm (max)		
Interface	eDP 1.2		
Surface Treatment	Anti-Glare On-cell		
Touch enabled	Yes		
Contrast Ratio	600:1 (typ)		
Refresh Rate	60 Hz		
Brightness	250 nits (typ)		
Pixel Resolution	Pitch	1920 x 1080 (FHD)	
	Format	RGB Stripe	
Backlight	LED		
Color Gamut Coverage	NTSC 45%		
Color Depth	6		
Viewing Angle	UWVA 85/85/85		
Low Blue Light	No		
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.54 (Max) / 3.12 (Max)		

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

15.6 in FHD (1920 x	Outline Dimensions (W × H)	349.460 x 204.790 (ma	x)
1080) Anti-Glare UWVA Low Blue Light sRGB NB2X 400 eDP 1.4+PSR2	Active Area	344.160 x 193.590 mm	(typ)
	Weight	310 g (max)	
Low-Power 100 bent LCD	Diagonal Size	15.6 (inch)	
Panel	Thickness	2.6 mm / 4.8 mm (max)
	Interface	eDP1.4	
	Surface Treatment	Anti-Glare	
	Touch enabled	No	
	Contrast Ratio	1200:1 (typ)	
	Refresh Rate	60 Hz	
	Brightness	400 nits (typ)	
	Pixel Resolution	Pitch	1920 x 1080 (FHD)
		Format	RGB Stripe
	Backlight	WLED	
	Color Gamut Coverage	sRGB 100%	
	Color Depth	8	
	Viewing Angle	UWVA 89/89/89/89	
	Low Blue Light	Yes	
	Power Consumption (W,	1.27 (max) / 1.5 (max)	



Technical Specifications – Displays

EBL@ 150nits max/ 200nits

max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

15.6 inch FHD	Outline Dimensions (W × H)	350.960 x 205.540 (ma	х)
(1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent NWBZ	Active Area	344.160 x 193.590 mm	(typ)
	Weight	370 g (max)	
	Diagonal Size	15.6	
	Thickness	3.0 mm / 5.0 mm (max)	
	Interface	eDP 1.2	
	Surface Treatment	Anti-Glare	
	Touch enabled	No	
	Contrast Ratio	600:1 (typ)	
	Refresh Rate	60 Hz	
	Brightness	250 nits (typ)	
	Pixel Resolution	Pitch	1920 x 1080 (FHD)
		Format	RGB Stripe
	Backlight	LED	
	Color Gamut Coverage	NTSC 45%	
	Color Depth	6 (Hi FRC w/ condition t	o enable)
	Viewing Angle	UWVA 85/85/85/85	
	Low Blue Light	No	
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.62 (Max) / 3.27 (Max)	
	4.611	and the second second second second	1.

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

15.6 in QHD (2560 x 1440) Anti-Glare UWVA Low Blue Light sRGB NWBZ 300 eDP 1.4+PSR2	Outline Dimensions (W x H)	350.960 x 205.550 (ma	(x)
	Active Area	344.2176 x 193.6224 n	nm
	Weight	300 g (max)	
100 120Hz bent LCD	Diagonal Size	15.6	
Panel	Thickness	2.6mm /4.6 mm (Max)	
	Interface	eDP 1.4	
	Surface Treatment	Anti-Glare	
	Touch Enabled	No	
	Contrast Ratio	1000:1(typ)	
	Refresh Rate	120 Hz	
	Brightness	300 nits (typ)	
	Pixel Resolution	Pitch	2560x1440 (QHD)
		Format	RGB Stripe



Technical Specifications – Displays

Backlight	WLED
Color Gamut Coverage	sRGB 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	3.41 (max) / 4.06 (max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

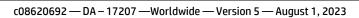


Technical Specifications – Storage

STORAGE AND DRIVES

(III)

SSD 512GB 2280 PCIe-	Form Factor	M.2 2280	
4x4 NVMe Three Layer	Capacity	512GB	
Cell	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read 6400 MB/s ±10%	Minimum Sequential Write 3500 MB/s ±10%
	Logical Blocks	1,000,215,215	
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]
	Features	Pyrite 2.0; TRIM; L1.2	
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for
SSD 1TB 2280 PCIe-4x4	Form Factor	M.2 2280	
NVMe Three Layer Cell	Capacity	1TB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen4X4	
	Performance	Minimum Sequential Read	Minimum Sequential Write
	Performance	Minimum Sequential Read 6400 MB/s ±10%	Minimum Sequential Write 5000 MB/s ±10%
	Performance Logical Blocks	•	-
		6400 MB/s ±10%	5000 MB/s ±10%
	Logical Blocks	6400 MB/s ±10% 2,000,409,264	5000 MB/s ±10%
	Logical Blocks Operating Temperature	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB =	5000 MB/s ±10%
SSD 2TB 2280 PCIe-4x4	Logical Blocks Operating Temperature	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell	Logical Blocks Operating Temperature Features	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB formatted capacity is less. Up system recovery software.	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor Capacity	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB formatted capacity is less. Up system recovery software. M.2 2280 2TB	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm)	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm) 0.87 in (22 mm)	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g)	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Gen4X4	5000 MB/s ±10% nient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCle NVMe Gen4X4 Minimum Sequential Read	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface Performance	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCle NVMe Gen4X4 Minimum Sequential Read 6400 MB/s ±10%	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write 5000 MB/s ±10%
	Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface Performance Logical Blocks	6400 MB/s ±10% 2,000,409,264 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 2TB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Gen4X4 Minimum Sequential Read 6400 MB/s ±10% 4,000,797,360	5000 MB/s ±10% ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write 5000 MB/s ±10%



Technical Specifications – Storage

		system recovery software.		
512GB PCIe-4x4 2280	Form Factor	M.2 2280		
NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive	Capacity	512GB		
	NAND Type	Opal2 TLC		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	0.02 lb (10 g)		
	Interface	PCIe NVMe Gen4X4		
	Performance	Minimum Sequential Read	Minimum Sequential Write	
		6400 MB/s ±10%	3500 MB/s ±10%	
	Logical Blocks	1,000,215,215		
	Operating Temperature	32° to 158°F (0° to 70°C) [amb	ient temp]	
	Features	TCG Opal 2.0; TRIM; L1.2		
			= 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
4TB PCIe-4x4 2280 NVMe	Form Factor	M.2 2280		
Three Layer Cell double-	Capacity	4TB		
sided M.2 Solid State Drive	NAND Type	TLC		
brive	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Weight	15g		
	Interface	PCIe NVMe Gen4X4		
	Performance	Minimum Sequential Read	Minimum Sequential Write	
			· · - • · · · ·	
		6400 MB/s ±10%	5000 MB/s ±10%	
	Logical Blocks	6400 MB/s ±10% 8,001,594,720	5000 MB/s ±10%	
	Logical Blocks Operating Temperature	-		
	-	8,001,594,720		
	Operating Temperature	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB =		
SSD 512GB 2280 PCIe	Operating Temperature	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
SSD 512GB 2280 PCIe NVMe Value	Operating Temperature Features	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software.	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
	Operating Temperature Features Form Factor	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
	Operating Temperature Features Form Factor Capacity	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
	Operating Temperature Features Form Factor Capacity NAND Type	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
	Operating Temperature Features Form Factor Capacity NAND Type Height	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm)	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
	Operating Temperature Features Form Factor Capacity NAND Type Height Width	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm)	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual	
	Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCle NVMe Minimum Sequential Read	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write	
	Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for	
	Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCle NVMe Minimum Sequential Read	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write	
	Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface Performance	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Minimum Sequential Read 2200 MB/s ±10%	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write 1000 MB/s ±10%	
	Operating Temperature Features Form Factor Capacity NAND Type Height Width Weight Interface Performance	8,001,594,720 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2 NOTE: For storage drives, GB = formatted capacity is less. Up system recovery software. M.2 2280 512GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCIe NVMe Minimum Sequential Read 2200 MB/s ±10% 1000215216 32° to 158°F (0° to 70°C) [amb Pyrite 2.0; TRIM; L1.2	ient temp] = 1 billion bytes. TB = 1 trillion bytes. Actual to 35 GB (for Windows 10) is reserved for Minimum Sequential Write 1000 MB/s ±10%	





Technical Specifications – Storage

system recovery software.



NETWORKING/COMMUNICATION

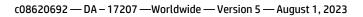
Realtek RTL8852CE 802.11ax 2x2 Wi-Fi 6E + Bluetooth® 5.3 (802.11ax 2x2, supporting gigabit data rate) wireless card [1]	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n/ax • 2.402 – 2.482 GHz
		802.11a/n/ac/ax • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz) 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ¹	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification IEEE 802.11i WAPI EAP
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming Output Power ²	IEEE 802.11 compliant roaming between access points • 802.11b : +17dBm minimum • 802.11g : +16dBm minimum • 802.11a : +17dBm minimum • 802.11n HT20(2.4GHz) : +14dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +14dBm minimum • 802.11n HT40(5GHz) : +10dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum



Technical Specifications – Networking

5			
		40(2.4GHz) : +12dBm minimum 80(5GHz) : +10dBm minimum	
	• 802.11ax HE160(5GHz) : +10dBm minimum		
	• 802.11ax HE80(6GHz) : +10dBm minimum		
		160(6GHz) : +10dBm minimum	
Power Consumption	• Transmit mode :2.5 V	V	
· · · · · · · · · · · · · · · · · · ·	Receive mode :2 W		
	• Idle mode (PSP) 180	mW (WLAN Associated)	
	• Idle mode :50 mW (W	LAN unassociated)	
		1odern Standby: 10mW	
	• Radio disabled: 8 mW		
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity ³	802.11b, 1Mbps : -93.5dBm maximum		
	802.11b, 11Mbps : -84		
	802.11a/g, 6Mbps : -8		
	802.11a/g, 54Mbps : -		
	802.11n, MCS07 : -67d		
	802.11n, MCS15 : -64d 802.11ac, MCS0(VHT8		
	802.11ac, MCS9(VHT8)		
		50) : -58.5dBm maximum	
		40): -57dBm maximum	
		30): -54dBm maximum	
	•802.11ax, MCS11(HE	160): -53.5dBm maximum	
Antenna Type	High efficiency antenn	a with spatial diversity, mounted in the	
	display enclosure		
		and 2.4/5/6 GHz antennas are provided to the	
	card to support WLAN MIMO communications and Bluetooth		
	communications		
Form Factor	PCI-Express M.2 MiniCa	ard	
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm		
	2. Type 1216: 1.67 x 1	2.0 x 16.0 mm	
Weight	1. Type 2230 : 2.8g		
	2. Type 126: 1.3g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating	14° to 158° F (-10° to 70° C)	
	Non-operating	-40° to 176° F (-40° to 80° C)	
Humidity	Operating	10% to 60% (non-condensing)	
	Non-operating	5% to 95% (non-condensing)	
Altitude	Operating Non-	0 to 10,000 ft (3,048 m)	
	operating	0 to 50,000 ft (15,240 m)	
LED Activity	N/A		
HP Integrated Module with Blueto	oth 4.0/4.1/4.2/5.0/5.	1/5.2/5.3 Wireless Technology	
Frequency Band	2402 to 2480 MHz		
Number of Available Channels	Legacy : 0~79 (1 MHz/	CH)	
	BLE : 0~39 (2 MHz/CH)		
Nata Datos and Theorebaut			
Data Rates and Throughput		ate; throughput up to 2.17 Mbps ; throughput up to 0.2 Mbps	
		, the oughput up to 0.2 Mops	

Legacy : Synchronous Connection Oriented links up to 3, 64 kbps,





Technical Specifications – Networking

Kbps asymmetricTransmit PowerThe Bluetooth co device with a maPower ConsumptionPeak (Tx): 330 m Peak (Rx): 230 m Selective SuspentBluetooth Software SupportedMicrosoft Window Microsoft WindowLink TopologyMicrosoft Window	W
device with a maPower ConsumptionPeak (Tx): 330 mPeak (Rx): 230 mSelective SuspenBluetooth Software SupportedMicrosoft WindowLink TopologyMicrosoft WindowPower ManagementMicrosoft WindowCertificationsFCC (47 CFR) PartPower ManagementETS 300 328CertificationsLow Voltage DirecCertificationsBT4.1-ESR 5/6/7Link Layer PinLink Layer PinLink Layer PinLink Layer Pin	ximum transmit power of + 4 dBm for BR and EDR. W W d: 17 mW ws Bluetooth Software ws ACPI, and USB Bus Support
Peak (Rx): 230 m Selective SuspenBluetooth Software SupportedMicrosoft WindowLink TopologyMicrosoft WindowPower ManagementMicrosoft WindowCertificationsFCC (47 CFR) PartPower ManagementETS 300 328CertificationsLow Voltage DirectBluetooth Profiles SupportedBT4.1-ESR 5/6/7LE Link Layer Pin LE Dual Mode	W Id: 17 mW ws Bluetooth Software ws ACPI, and USB Bus Support
Link TopologyPower ManagementMicrosoft WindowCertificationsFCC (47 CFR) PartPower ManagementETS 300 328CertificationsLow Voltage DirectCertificationsBluetooth Profiles SupportedBluetooth Profiles SupportedBT4.1-ESR 5/6/7LE Link Layer Pin LE Dual ModeLow de line	ws ACPI, and USB Bus Support
Power ManagementMicrosoft WindowCertificationsFCC (47 CFR) PartPower ManagementETS 300 328CertificationsLow Voltage Dire CE MarkBluetooth Profiles SupportedBT4.1-ESR 5/6/7L Link Layer Pin LE Dual Mode	••
Power ManagementETS 300 328CertificationsLow Voltage DirectBluetooth Profiles SupportedBT4.1-ESR 5/6/7LE Link Layer Pin LE Dual Mode	t 15C, Section 15.247 & 15.407
Power ManagementETS 300 328CertificationsLow Voltage DirectBluetooth Profiles SupportedBT4.1-ESR 5/6/7LE Link Layer Pin LE Dual Mode	
LE Link Layer Pin LE Dual Mode	ective
LE Low Duty Cycl LE L2CAP Connec Train Nudging & BT4.2 ESR08 Cor LE Secure Conne LE Privacy 1.2 –L LE Privacy 1.2 –E LE Data Packet L FAX Profile (FAX) Basic Imaging Pr Headset Profile (Hands Free Profi Advanced Audio BT5.2 ESR9/10 Complia LE Advertisemen Channel Selectio	g e Directed Advertising tion Oriented Channels Interlaced Scan npliance ction- Basic/Full ink Layer Privacy extended Scanner Filter Policies ength Extension ofile (BIP)2 HSP) le (HFP) Distribution Profile (A2DP) ance t Extensions n Algo y Cycle Non-Connectable Advertising

*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

[2] Check latest software/driver release for updates on supported security features.

[3] The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

[4] Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



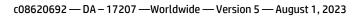
Mediatek RZ616 Wi-Fi 6E + Bluetooth® 5.3 (802.11ax 2x2, supporting gigabit data rate) wireless card [1]	E Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11ac IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11j IEEE 802.11j IEEE 802.11k IEEE 802.11mc IEEE 802.11v IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n/ax • 2.402 – 2.482 GHz
		802.11a/n/ac/ax • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz • 5.925 – 7.125 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz) 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ¹	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification IEEE 802.11i WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming Output Power ²	IEEE 802.11 compliant roaming between access points 2.4GHz (MIMO, typical): • 802.11b : +18dBm • 802.11g : +16.5dBm • 802.11n/ac/ax (HT20/VHT20/HE20) : +16dBm • 802.11n/ac/ax (HT40/VHT40/HE40) : +12.5dBm

5GHz (MIMO, typical):



Technical Specifications – Networking

 802.11ax HE160 : +11.5dBm 6GHz LPI mode (MIMO, typical):: 802.11a : 0dBm 802.11ax HE20 : +1dBm 802.11ax HE40 : +4dBm 802.11ax HE80 : +7dBm 802.11ax HE160 : +7.5dBm
Power Consumption • Transmit mode :2.5 W • Receive mode :2 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode :50 mW (WLAN unassociated) • Connected Standby/Modern Standby: 10mW • Radio disabled: 8 mW
Power Management ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³ 2.4GHz (SISO): •802.11b, 11Mbps : -82dBm maximum •802.11g, 54Mbps : -71dBm maximum •802.11n, MCS7 : -64dBm maximum •802.11ac, MCS9 : -52dBm maximum •802.11ax, MCS11(HT40): -49dBm maximum •802.11a, 54Mbps : -71dBm maximum •802.11ac, MCS9 : -52dBm maximum •802.11ax, MCS11(HE80/HE160): -46dBm maximum •802.11a, 54Mbps : -71dBm maximum
Antenna Type High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor PCI-Express M.2 MiniCard
Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Weight 1. Type 2230 : 2.8g 2. Type 126: 1.3g
Operating Voltage 3.3v +/- 9%
Temperature Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)
HumidityOperating10% to 60% (non-condensing)Non-operating5% to 95% (non-condensing)
Altitude Operating 0 to 10,000 ft (3,048 m) operating 0 to 50,000 ft (15,240 m)





LED Activity	N/A
HP Integrated Module with Bluet	ooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Technology
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class 1.5 Bluetooth device with a maximum transmit power of + 14 dBm and 10 dBm for BR and EDR, respectively.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	
Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.407
Power Management Certifications	
	ETS 300 328 Low Voltage Directive CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range Windows BT profiles support



BT5.3

Periodic Advertisement interval Encryption key size control enhancements

*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

[2] Check latest software/driver release for updates on supported security features.

[3] The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

[4] Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

NFC Mirage module (NXP NPC300 I2C 10mmx17mm)

Dimensions (L x W x H)	Module 25 mm by 10 mm by 2.0 mm
Chipset	NPC300
System interface	I2C
NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
NFC Forum Support	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2
Reader (PCD-VCD) Mode	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards
Card Emulation (PICC- VICC) Mode	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa
Frequency	13.56 MHz
NFC Modes Supported	Reader/Writer, Peer-to-Peer
Raw RF Data Rates	106, 212, 424, 848 kbps
Operating temperature	0°C to 70°C
Storage temperature	-20°C to 125°C
Humidity	10-90% operating 5-95% non-operating
Supply Operating voltage	4.35 to 5.25 Volts
I/O Voltage	1.8V or 3.3V
Power Consumption	Booster enable, VBAT= 3.3V,





	Antenna	VCC_BOOST = 5V) Mode Power Consumption, Typical Antenna connector external to module	Tag Type 4 , 0.5mm pitch, 7	7.3 mA Total 283.8 mA Net Module 236.8 mA Total 288.8 mA Net Module 241.8 mA Total 287.7 mA Net Module 240.7 mA Total 282.3 mA Net Module 235.3 mA connector FPC. Antenna matching is
Realtek RTL8111FPH 10/ [.]	100/1000 Integrated NIC			
Connector	RJ-45			
System Interface	PCIe + SMBus			
Data rates supported	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)			
IEEE Compliance	IEEE 802.3x Flow Contro IEEE 802.3az EEE (Energ			able)
Performance	TCP/IP/UDP Checksum (Protocol Offload (ARP & Large send offload and Receiving Side Scaling Jumbo Frame 9K	Dffload (configurable NS)		
Power consumption	Cable Disconnetion: 25n 100Mbps Full Run: 450n 1000bp Full Run: 1000n WoL Enable(S3/S4/S5): WoL Disable(S3/S4/S5):	nW nW 50mW		
· · · · · · · · · · · · · · · · · · ·	ACPI compliant – multip			
Power	Situation-sensitive feat	ures reduce power c	•	
Management	Advanced link down pov	ver saving for reduci	ng link down pov	ver consumption
Management Interface	LAN from off (Magic Pac PXE 2.1 Remote Boot	ndby and hibernation ket only)		nd Microsoft Wake-Up Frame); Wake-on-
IT Manageability Security & Manageability	Comprehensive diagnos Virtual Cable Doctor for	tic and configuration Ethernet cable statu	software suite	: MIB (802.3x, clause 30))

Realtek RTL8111HSH 10/100/1000 Integrated NIC

Connector	RJ-45
System Interface	PCIe + SMBus
Data rates supported	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)



	100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)
	1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection)
	Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	IEEE 802.1p QoS (Quality of Service) Support
	IEEE 802.1g VLAN support
	IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)
IEEE Compliance	IEEE 802.3az EEE (Energy Efficient Ethernet)
	TCP/IP/UDP Checksum Offload (configurable)
	Protocol Offload (ARP & NS)
	Large send offload and Giant send offload
Performance	Receiving Side Scaling Jumbo Frame 9K
	Cable Disconnetion: 25mW 100Mbps Full Run: 450mW
	1000bp Full Run: 1000mW
	WoL Enable(S3/S4/S5): 50mW
Power consumption	WoL Disable(S3/S4/S5): 25mW
	ACPI compliant – multiple power modes
Power	Situation-sensitive features reduce power consumption
-	Advanced link down power saving for reducing link down power consumption
-	Auto MDI/MDIX Crossover cable detection
	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-
	LAN from off (Magic Packet only) PXE 2.1 Remote Boot
	Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))
	Comprehensive diagnostic and configuration software suite
IT Manageability	Virtual Cable Doctor for Ethernet cable status
AUDIO	
HD Stereo Codec	Realtek ALC3247
Audio I/O Ports	Headset : CTIA only and Headphone-out
Internal Speaker	Realtek Class-D
Amplifier	
	Playback multi-streaming can be enabled in the audio control panel to allow independent audio. Following MSFT Behaviour
	DAC:48kHz ADC:48kHz
Wavetable Syntheses	
Analog Audio	Support 3.5mm Headset : CTIA only and Headphone-out
# of Channels on Line-	
Out	
Internal Speaker	Yes

FINGERPRINT READER

Sensor vendor	ELAN 80SW
Sensor type	Capacitive
DPI resolution	508 DPI



Scan	area	80x80 pixels
False	Rejection Rate	<3%
False	Acceptance Rate	< 0.001%
Mobil	e Voltage Operation	2.7~3.6V
Opera	ting Temperature	-20°C - +80°C
Curre	nt Consumption	35mA peak
Image	2	
Low L	atency Wait For	300uA
Finge	r	
Captu	ire Rate	Capture Rate: 50 frame/sec
ESD R	esistance	IEC 61000-4-2 4B (+15KV)
Detec	tion Matrix	508 dpi / 4x4mm sensor area

POWER

AC Adapter 150 Watt	Dimensions	5.43 x 2.59 x 0.39 in (13.8x6.6x2.2cm)		
Smart PFC Slim Barrel 4.5mm Right Angle	Weight	0.716 lb (325 g) max (Not including power cord. Power cord varies by country.)		
	Input	Input Efficiency	88% at 115 Vac and 89% at 230Vac	
		Input frequency range	47 ~ 63 Hz	
		Input AC current	Max. 2.7 A at 90 Vac	
	Output	Output power	150W	
		DC output	19.5V	
		Hold-up time	100% load 5ms at 115 Vac input	
		Output current limit	<16.0A	
	Connector	C6		
		DC Plug	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)	
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)	
		Altitude	0 to 16,400 ft (0 to 5000m)	
		Humidity	20% to 95	
		Storage Humidity	10% to 95%	
	EMI and Safety Certifications	*CE Mark - full compliance with LVD and EMC directives *Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL62368-1 *Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC		
AC Adapter 120 Watt	Dimensions	5.433 x 2.697 x 1.0 in (13.	8x6.85x2.54cm)	
Smart PFC Slim Barrel	Weight	0.88 lb (400 g) max (Not including power cord. Power cord varies by		



4.5mm	Riaht	Anale

_		
	country.)	
Input	Input Efficiency	88% at 115 Vac and 89% at 230Vac
	Input frequency range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
Output	Output power	120W
	DC output	19.5V
	Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input
	Output current limit	<18.0A
Connector	C6	
	DC Plug	4.5mm Barrel Type
Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95
	Storage Humidity	10% to 95%
EMI and Safety Certifications	*CE Mark - full compliance with LVD and EMC directives *Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL62368-1 *Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark,	

Australia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC

Technical Specifications – Power

Battery 6 Cell WHr 83 Long Life -PL Fast Charge	Dimensions (H x W x L) Weight	7.78 x 316.1 x70.2mm (0.306 x 12.44 x 2.763 inch) 0.31kg (0.683lb)		
	Cells/Type	6cell Lithium-Ion Polymer cell / 685257		
	Energy	Voltage	11.58V	
		Amp-hour capacity	7.170Ah	
		Watt-hour capacity	83Wh	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 122° F (-10° to 60° C)	
	Fuel Gauge LED	NA		
	Warranty	Refer to http://www.hp.co warranty information.	om/support/batterywarranty/ for battery	
	Optional Travel Battery Available	N/A		
	*Batteries have a default of 1-year or 3-year limited w		xcept for Long Life batteries which will have same	



ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	 This product has received or is in the process of being certified to the following approvals and mabe labeled with one or more of these marks: IT ECO declaration US ENERGY STAR[®] US Federal Energy Management Program (FEMP) EPEAT^O Gold registered in the United States. See http://www.epeat.net for registration status in your country. TCO Certified China Energy Conservation Program (CECP) China State Environmental Protection Administration (SEPA) Taiwan Green Mark Korea Eco-label Japan PC Green label* 		
Sustainable Impact Specifications	 Product Carbon Footprint (hp.com) Ocean-bound plastic in Speaker 14.3% post-consumer recycled plastic 50% recycled metal Low halogen Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable Bulk packaging available 		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".		
Energy Consumption (in accordance with US ENERGY STAR® test method)	•	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	7.38 W	7.29 W	7.17 W
Normal Operation (Long idle)	N/A	N/A	N/A
Sleep	3.62 W	3.74 W	3.55 W
Off	0.36 W	0.40 W	0.36 W
	NOTE: Energy efficiency data listed is for family. HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Misrocoft Windows® aparating systems	n the ENERGY STAR® Logo are con (EPA) ENERGY STAR® specification R® compliant configurations, the ring a hard disk drive, a high effic	mpliant with the applicable U.S. ons for computers. If a model n energy efficiency data listed is

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	25 BTU/hr	25 BTU/hr	25 BTU/hr
Normal Operation (Long idle) Sleep	N/A 12 BTU/hr	N/A 13 BTU/hr	N/A 12 BTU/hr

Microsoft Windows® operating system.



Off	1 8	3TU/hr	1 BTU/hr	1 BTU/hr	
	* NOTE: Heat d attained for or		based on the measured v	watts, assuming the service level is	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (L _{wad} , bels)		Sound Pressure (L _{PAm} , decibels)	
Typically Configured – Idle		2.6		13.	
Fixed Disk – Random writes		2.7		13.6	
Optical Drive – Sequential reads		3.5		25.6	
Longevity and Upgrading		an be upgraded, possibly or components contained		e by several years. Upgradeable	
	Spare parts ar production.	e available throughout t	he warranty period and	or for up to "5" years after the end of	
Additional Information	direct • This F (WEE	tive - 2011/65/EC. IP product is designed to E) Directive – 2002/96/E	o comply with the Waste C.	Hazardous Substances (RoHS) Electrical and Electronic Equipment	
	 This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see 				
	•	.epeat.net		All'stalluaru at the dotu tevel, see	
	• Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and			duct are marked per ISO11469 and	
	 ISO1043. This product is 94.3% recycle-able when properly disposed of at end of life. 				
Packaging Materials	External:	PAPER/Corrugated		295g	
		PAPER/Molded pulp		170g	
	Internal:	PLASTIC/Polyethylene	low density-LDPE	10g	
	The plastic pa	ackaging material contai	ns at least 0.0% recycle	d content.	
	The corrugate	ed paper packaging mate	erials contains at least 5	8.8% recycled content.	
RoHS Compliance	restrictions in products world	the European Union (EU)	Restriction of Hazardou E. HP has contributed to	ong the first companies to extend the us Substances (RoHS) Directive to our o the development of related	
	We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.			nclusion of additional substances—	
				and we will continue to extend the	



	To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):
	 Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP) Dibutyl phthalate (DBP) Diisobutyl phthalate (DIBP) Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl CHBBS) Polybrominated Biphenyl Oxides (PBBOs) Polybroliniated Biphenyl (PCB) Polychlorinated Biphenyl (PCT) Polyvlorinated Biphenyl (PCT) Polyvlorinated Biphenyl (PCT) Polyvlorinated Biphenyl (PCT) Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers.



These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h2O195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
Footnotes	 ¹Percentage of ocean-bound plastic contained in each component varies by product ²Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. ³External power supplies, WWAN modules, power cords, cables and peripherals excluded. ⁴100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. ⁵Fiber cushions made from 100% recycled wood fiber and organic materials. ⁶Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams

Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Cases	HP Prelude Pro Recycle Backpack	1X644AA
	HP Prelude Pro Recycle Top Load	1X645AA
	HP Prelude 15.6 Top Load	1E7D7AA
	HP Prelude 15.6 Top Load	2Z8P4AA
	HP Prelude 15.6 Top Load	50P31AA
	HP Prelude 15.6 Backpack	1E7D6AA
	HP Prelude 15.6 Backpack	2Z8P3AA
	HP Prelude 15.6 Backpack	50P32AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Executive 16 Laptop Backpack	6B8Y1AA
	HP Renew Executive 16 Laptop Bag	6B8Y2AA
	HP Travel 25 Liter 15.6 Iron Gray Laptop Backpack	6B8U4AA
	HP Travel 25 Liter 15.6 Iron Gray Laptop Backpack	6H2D8AA
	HP Travel 18 Liter 15.6 Iron Gray Laptop Backpack	6B8U6AA
	HP Travel 18 Liter 15.6 Iron Gray Laptop Backpack	6H2D9AA
Docking Station	HP USB-C Dock G5	26D32AA
	HP USB-C Dock G5	5TW10AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP USB-C/A Universal Dock G2 TAA	7UP88AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4JOG4AA
Adapter/Dongle	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to VGA Adapter	P7Z54AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to HDMI 2.0 Adapter	2PC54AA
	HP 7.4 mm to 4.5 DC dongle	КОДЗЭАА
	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB-C to RJ45 Adapter G2	4Z534AA
	HP USB 3.0 to Gig RJ45 Adapter G2	4Z7Z7AA
	HP USB-C to USB-C 100W Cable	5AR72AA
Audio/Video	HP USB G2 Stereo Headset	428H5AA
	HP USB G2 Stereo Headset	428K6AA
	HP 3.5mm G2 Stereo Headset	428H6AA
	HP 3.5mm G2 Stereo Headset	428K7AA
	HP 365 BT Speaker	567D3AA



Options and Accessories (sold separately and availability may vary by country)

	HP 325 FHD USB-A Webcam	53X27AA
	HP 965 4K Streaming Webcam	695J5AA
	HP 620 FHD Webcam	6Y7L2AA
Hub	HP USB-C to USB-A Hub	Z6A00AA
<u>Ctores</u>	UD E12CD DCIe. 4v4 NVMe M 2 Celid State Drive	FDOVOAA
Storage	HP 512GB PCIe-4x4 NVMe M.2 Solid State Drive HP 1TB PCIe-4x4 NVMe M.2 Solid State Drive	5R8X9AA 5R8Y0AA
	HP 2TB PCIe-4x4 NVMe TLC M.2 Solid State Drive HP USB External DVDRW Drive	
	HP USD External DVDRW Drive	F2B56AA,Y3T76AA
Keyboard/Comb	• HP 320K Wired Keyboard	9SR37AA
	HP 125 Wired Keyboard	266C9AA
	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 355 Compact Multi-Device Keyboard	692S9AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 225 Antimicrobial Wired Mouse and Keyboard Combo	286K3AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 155 Wired Mouse and Keyboard Combo	5B8COAA
Display	HP Z24f G3 FHD Display	3G828AA
	HP Z27q G3 QHD Display	1C4Z7AA
	HP Z24n G3 WUXGA Display	1C4Z5AA
	HP Z34c G3 WQHD Curved Display	30A19AA
	HP Z24q G3 QHD Display	4Q8N4AA
	HP Z24m G3 QHD Conferencing Display	4Q8N9AA
	HP Z32k G3 4K USB-C Display	50U19AA
Mouse	HP Wired 320M Mouse	9VA80AA
	HP Travel USB Mouse	G1K28AA
	HP Premium Wireless Mouse	1JR31AA
	HP Travel Bluetooth Mouse	6SP30AA
	HP Multi-Device 635 Black Wireless Mouse	1D0K2AA
	HP Creator 935 Black Wireless Mouse	1DOK8AA
	HP 235 Slim Wireless Mouse	4E407AA
	HP 128 LSR Wired Mouse	265D9AA
	HP 125 Wired Mouse	265A9AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 155 Wired Mouse	5B8B7AA
	HP 715 Rechargeable Multi-Device Bluetooth Mouse	6E6F0AA



Options and Accessories (sold separately and availability may vary by country)

	HP 925 Ergonomic Vertical Wireless Mouse	6H1A5AA
Power Adapter	HP 150W Slim Smart 4.5mm AC Adapter	4SC18AA
	HP ZBook 200W Slim Smart 4.5mm AC Adapter	491C7AA
	HP ZBook 230W Slim Smart 4.5mm AC Adapter	6E6M1AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP Sure Key Cable Lock	6UW42AA
	HP Nano Combination Cable Lock	63B28AA
	HP Essential Nano Combination Cable Lock	63B31AA



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Date of change:	Version History:		Description of change:
July 5, 2023	From v1 to v2	Changed	ENVIRONMENTAL DATA section
July 20, 2023	From v2 to v3	Changed	PROCESSOR section
July 25, 2023	From v3 to v4	Changed	GRAPHICS section
August 1, 2023	From v4 to v5	Changed	ENVIRONMENTAL DATA section

